



S1C17W22D101100 Information

Heisener.com

Part Number S1C17W22D101100

Manufacturer Epson Electronics America Inc-Semiconductor Div

Category Integrated Circuits (ICs)

Embedded - Microcontrollers

Description IC MCU 16BIT 64KB FLASH DIE

Package Die

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









S1C17W22D101100 Specifications

Manufacturer Part Number	S1C17W22D101100
Manufacturer	Epson Electronics America Inc-Semiconductor Div
Category	Integrated Circuits (ICs)
	Embedded - Microcontrollers
Package	Die
Series	-
Core Processor	S1C17
Core Size	16-Bit
Speed	4.2MHz
Connectivity	I2C, IrDA, SPI, UART/USART
Peripherals	LCD, PWM, RFC, WDT
Number of I/O	41
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.2 V ~ 3.6 V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	Die
Supplier Device Package	Die
	Report errors?

S1C17W22D101100 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

S1C17W22D101100 Payment Methods

































If you have any question about S1C17W22D101100, please do not hesitate to contact us!

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